



VOIDLESS HERMETICALLY SEALED SWITCHING DIODES

Qualified per MIL-PRF-19500/578

Qualified Levels: JAN, JANTX, JANTXV and JANS

DESCRIPTION

This popular surface mount equivalent JEDEC registered switching/signal diodes are military qualified and available with internal metallurgical bonded construction. These small low capacitance diodes with very fast switching speeds are hermetically sealed and bonded into a "D-5D" package. They may be used in a variety of fast switching applications including computers and peripheral equipment such as magnetic cores, thin-film memories, plated-wire memories, as well as decoding or encoding applications, etc. Microsemi also offers a variety of other switching/signal diodes.

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- JEDEC registered surface mount equivalents of 1N6638, 1N6642, and 1N6643.
- Ultra fast recovery time.
- Very low capacitance.
- Metallurgically bonded.
- Non-cavity glass package.
- JAN, JANTX, JANTXV and JANS qualifications are available per MIL-PRF-19500/578.
- Replacements for 1N4148UR, 1N4148UR-1, 1N4150UR-1, and 1N914UR.
- RoHS compliant devices available (commercial grade only).

APPLICATIONS / BENEFITS

- Small size for high density mounting (see package illustration).
- Ideal for:

High frequency data lines

RS-232 & RS-422 Interface Networks

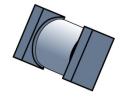
Ethernet: 10 Base T Switching core drivers

LAN Computers

MAXIMUM RATINGS @ T_A = +25 °C unless otherwise noted.

Parameters/Test Conditions	Symbol	Value	Unit	
Junction and Storage Temp	T _J and T _{STG}	-65 to +175	°C	
Thermal Resistance Junction-to-End	$R_{\Theta JEC}$	40	°C/W	
Thermal Resistance Junction-to-Amb	R _{OJA}	250	°C/W	
Peak Forward Surge Current @ T _A = (Test pulse = 8.3 ms, half-sine wave.)	I _{FSM}	2.5	Α	
Average Rectified Forward Current @ (Derate at 4.6 mA/°C Above T _{EC} = + 1	lo	300	mA	
Breakdown Voltage: 1N6638US 1N6642US 1N6643US		V _{BR}	150 100 75	V
Working Peak Reverse Voltage: 1N6638US 1N6642US		V _{RWM}	125 75	V
	1N6643US		50	

NOTES: 1. T_A = +75 °C on printed circuit board (PCB), PCB = FR4 - .0625 inch (1.59 mm) 1-layer 1-Oz Cu, horizontal, in still air; pads for US = .061 inch (1.55 mm) x .105 inch (2.67 mm); R_{OJA} with a defined PCB thermal resistance condition included, is measured at I_O = 300 mA.



"D" SQ-MELF (D-5D) Package

Also available in:

"D" Package
(axial-leaded)
1N6638 42 43

MSC – Lawrence

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Website:

www.microsemi.com



MECHANICAL and PACKAGING

- CASE: Voidless hermetically sealed hard glass.
- TERMINALS: Tin-Lead plate with >3% Lead. Solder dip is available upon request.
- MARKING: Body painted and alpha numeric.
- POLARITY: Cathode indicated by band.
- Tape & Reel option: Standard per EIA-481-1-A with 12 mm tape. Consult factory for quantities.
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE JAN 1N6638 US (e3)**RoHS Compliance Reliability Level** JAN = JAN Level e3 = RoHS compliant (available JANTX = JANTX Level on commercial grade only) JANTXV = JANTXV Level Blank = non-RoHS compliant JANS = JANS Level Blank = commercial **Surface Mount Package** JEDEC type number See Electrical Characteristics

SYMBOLS & DEFINITIONS					
Symbol	Definition				
V_{BR}	Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current.				
V_{RWM}	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range.				
V_{F}	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.				
I _R	Maximum Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.				
С	Capacitance: The capacitance in pF at a frequency of 1 MHz and specified voltage.				
t _{rr}	Reverse Recovery Time: The time interval between the instant the current passes through zero when changing from the forward direction to the reverse direction and a specified recovery decay point after a peak reverse current is reached.				

ELECTRICAL CHARACTERISTICS @ 25°C unless otherwise noted.

TYPE NUMBER	MAXIMUM FORWARD VOLTAGE V _F @ I _F		MAXIMUM DC REVERSE CURRENT			REVERSE RECOVERY TIME t _{rr} (Note 1)	MAXIMUM FORWARD RECOVERY VOLTAGE AND TIME I _F =200mA, t,=1ns		MAXIMUM JUNCTION CAPACITANCE f = 1 MHz Vsig = 50 mV		
			V _R = 20 V	V _R =V _{RWM}	I _{R3} V _R =20 V T _A = +150 °C	I _{R4} V _R =V _{RWM} T _A = +150 °C		V _{FRM}	t _{fr}	ν _R =0 V	-p) V _R =1.5 V
	V @ mA	V @ mA	nA	nA	μА	μА	ns	٧	ns	pf	pf
1N6638US	0.8 V @ 10 mA	1.1 V @ 200 mA	35	500	50	100	4.5	5.0	20	2.5	2.0
1N6642US	0.8 V @ 10 mA	1.2 V @ 100 mA	25	500	50	100	5.0	5.0	20	5.0	2.8
1N6643US	0.8 V @ 10 mA	1.2 V @ 100 mA	50	500	75	100	6.0	5.0	20	5.0	2.8

NOTE: 1. Reverse Recovery Time Test Conditions – I_F=I_R=10 mA, I_{R(REC)} = 1.0 mA, C=3 pF, R_L = 100 ohms.



GRAPHS

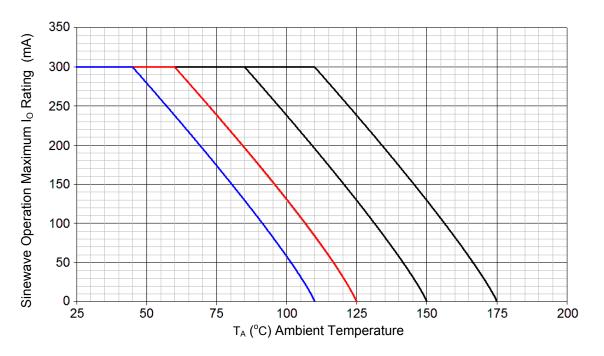


FIGURE 1
Temperature – Current Derating

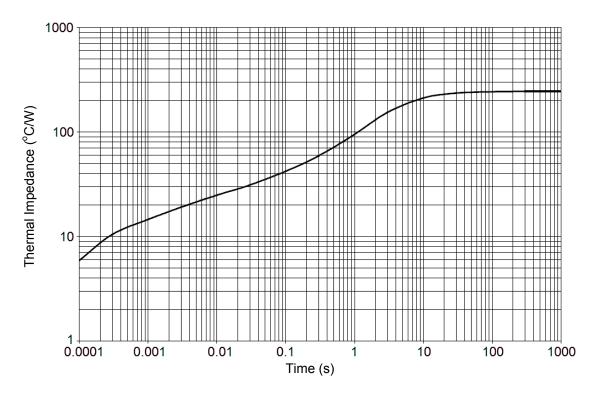


FIGURE 2 Maximum Thermal Impedance at $T_A = 55$ °C



GRAPHS (continued)

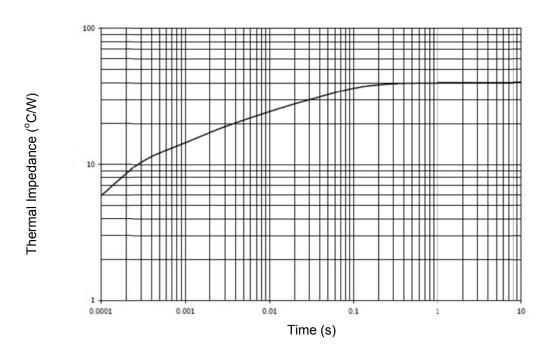
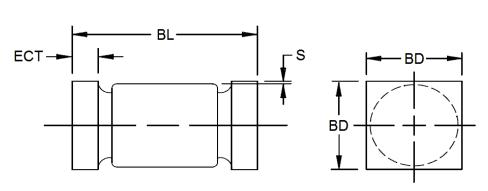


FIGURE 3 Maximum Thermal Impedance at T_{EC} = 25 $^{\circ}C$



PACKAGE DIMENSIONS

D-5D



	IN	СН	MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
BD	BD 0.070 0.085		1.78	2.16		
ECT	0.019	0.028	0.48	0.71		
BL	0.165	0.195	4.19	4.95		
s	0.003	3 MIN.	0.08 MIN.			

NOTES:

- 1. Dimensions are in inches. Millimeters are given for general information only.
- 2. Dimensions are pre-solder dip.
- U-suffix parts are structurally identical to the US-suffix parts.
 In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip:

<u>JANS1N6638U</u> <u>JANTX1N6643U</u> <u>JAN1N6638U</u> <u>JANTXV1N6638U</u> <u>JANTX1N6638US</u> <u>JAN1N6643US</u> <u>JANTX1N6638US</u> <u>JANTX1N6638US</u> <u>JANTX1N6638US</u> <u>JANTX1N6638US</u> <u>JANTX1N6638US</u> <u>JANTX1N6638US</u> <u>JANTX1N6638US</u> <u>JANTXV1N6642US</u> <u>JANTXX</u>